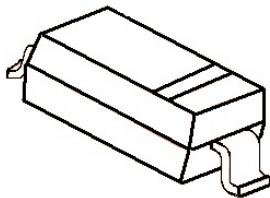


SOD-123

特征 Features

- 齐纳击穿阻抗低; Low Zener Impedance
- 最大功率耗散 500mW; Power Dissipation of 500mW
- 高稳定性和可靠性。High Stability and High Reliability

机械数据 Mechanical Data

- 封装: SOD-123 封装 SOD-123 Small Outline Plastic Package
- 极性: 色环端为负极 Polarity: Color band denotes cathode end
- 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

极限值和温度特性(TA = 25°C 除非另有规定)

Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
功率消耗 Power Dissipation	Pd	500 ¹⁾	mW
正向压降 Forward Voltage @IF=10mA	Vf	0.9 ²⁾	V
热阻 Thermal Resistance, Junction to Ambient Air	R _{θJA}	357	°C/W
工作结温 Junction/Operating Temperature	Tj	150	°C
存储温度 Storage temperature range	Ts	-65-+150	°C

1) Device mounted on ceramic PCB: 7.6mm x 9.4mm x 0.87mm with pad areas 25mm²

2) Short duration test pulse used to minimize self-heating effect

3) f=1KHz

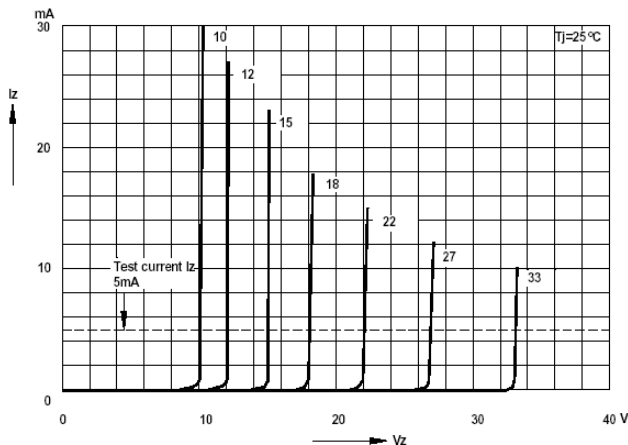
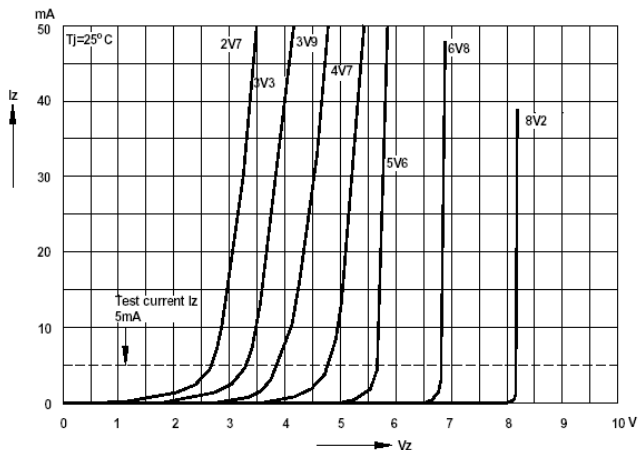
电特性 (TA = 25°C 除非另有规定)

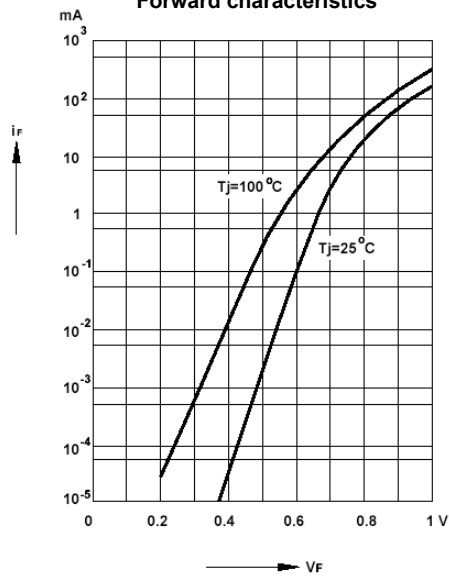
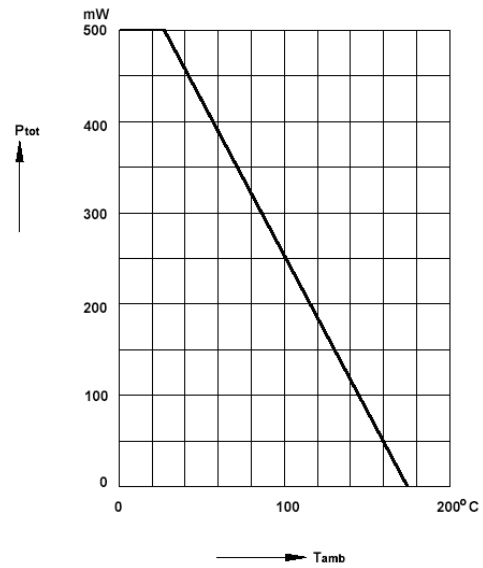
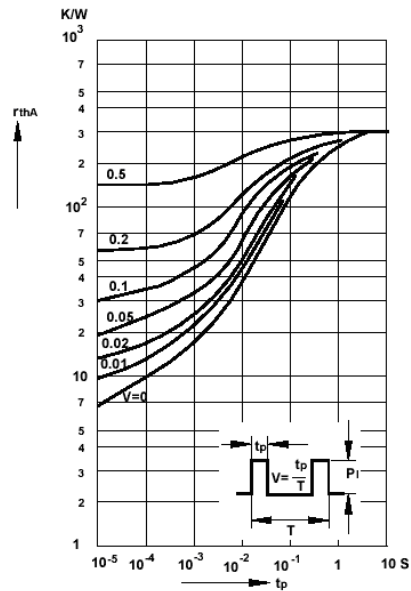
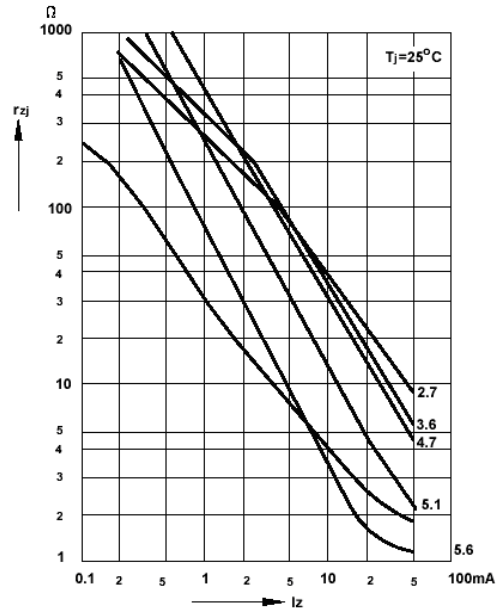
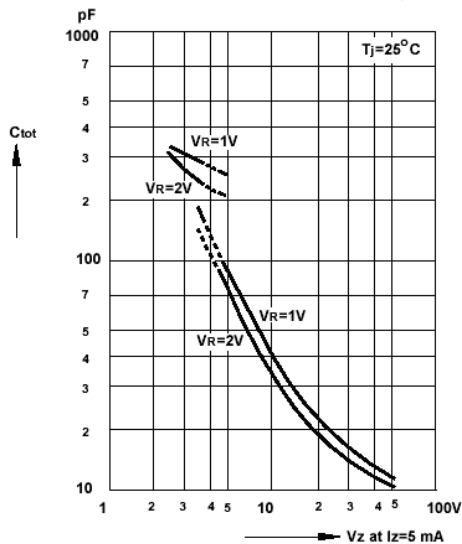
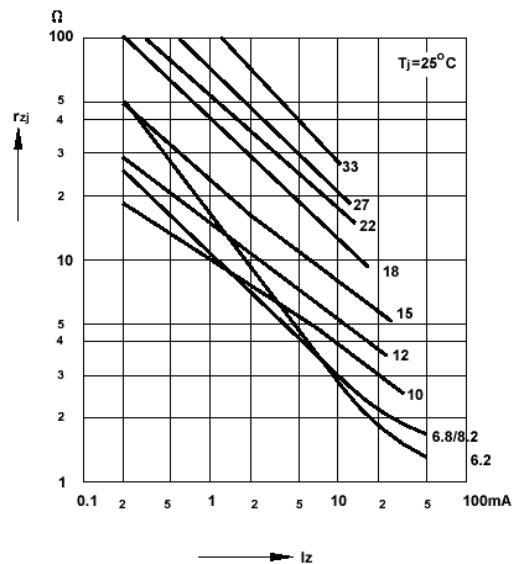
Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

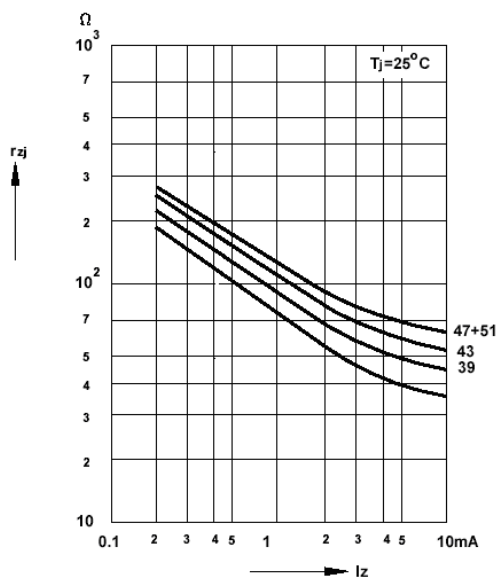
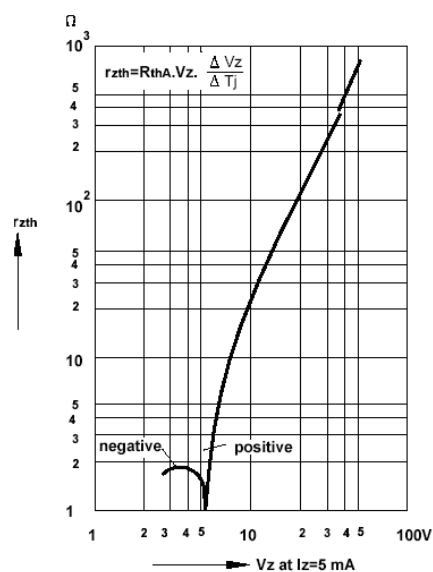
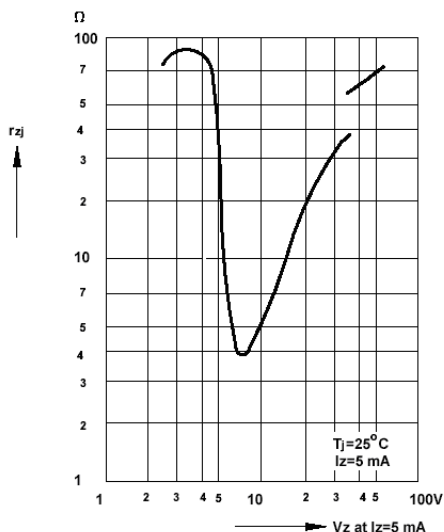
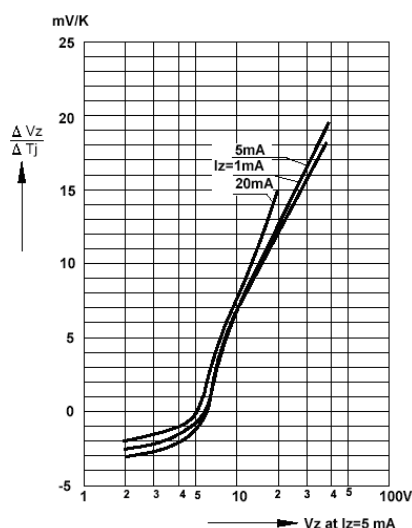
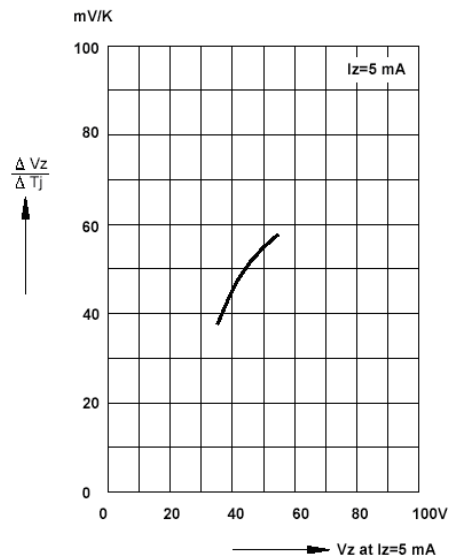
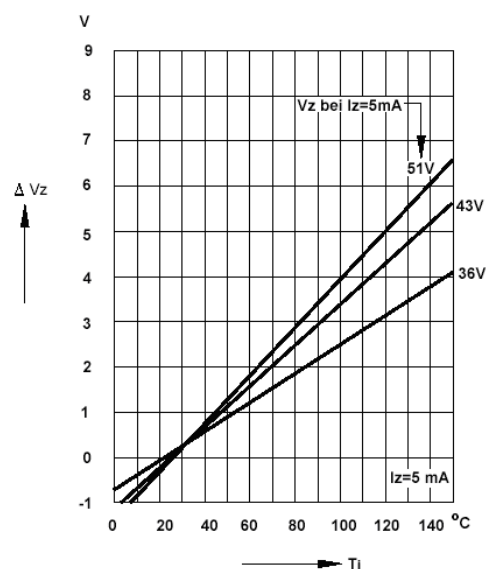
Device	Marking	Zener Voltage Range				Maximum Zener Impedance			Maximum Reverse Current		Typical Temperature coefficient @ IZTC=mV/°C		Test Current IZTC
		Vz@Izt			Izt	Zzt @Izt	Zzk @Izk	Izk	IR	VR			
		Nom(V)	Min(V)	Max(V)	mA	Ω		mA	uA	V	Min	Max	mA
MMSZ4697T1G-CN	2WF	10	9.80	10.20	5	20	150	1.0	0.2	7.0	4.5	8.0	5

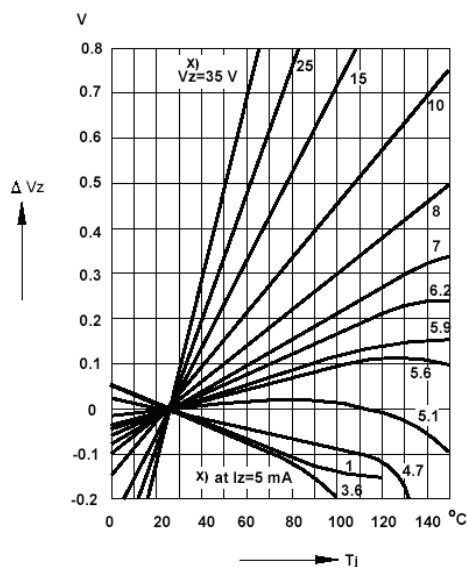
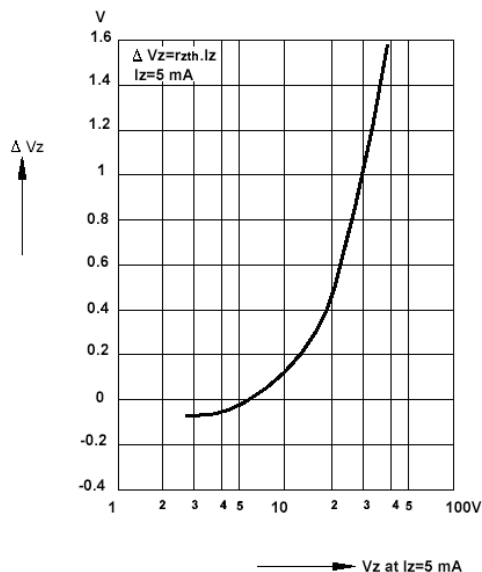
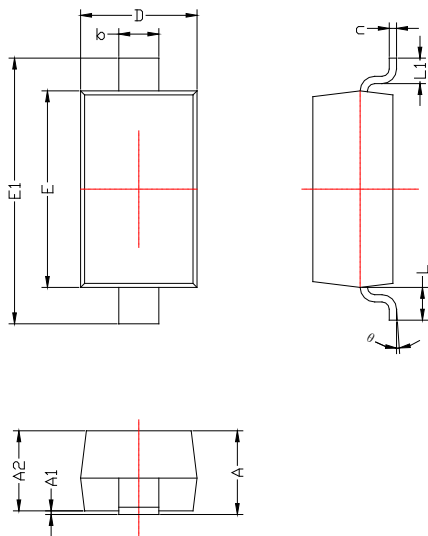
Breakdown characteristics

at Tj=constant (pulsed)



Forward characteristics

Admissible power dissipation versus ambient temperature

Pulse thermal resistance versus pulse duration

Dynamic resistance versus Zener current

Capacitance versus Zener voltage

Dynamic resistance versus Zener current


Dynamic resistance versus Zener current

Thermal differential resistance versus Zener voltage

Dynamic resistance versus Zener voltage

Temperature dependence of Zener voltage versus Zener voltage

Temperature dependence of Zener voltage versus Zener voltage

Change of Zener voltage versus junction temperature


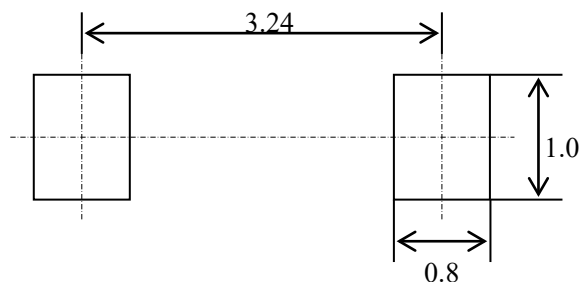
Change of Zener voltage versus junction temperature

Change of Zener voltage from turn-on up to the point of thermal equilibrium versus Zener voltage

SOD-123 PACKAGE OUTLINE Plastic surface mounted package


SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.450	0.650
c	0.080	0.150
D	1.500	1.700
E	2.600	2.800
E1	3.550	3.850
L	0.500REF	
L1	0.250	0.450
θ	0°	8°

焊盘设计参考

Precautions: PCB Design

Recommended land dimensions for SOD-123 diode. Electrode patterns for PCBs



中心距: 3.24

脚 宽: 0.55

焊盘宽: 1.00

脚 长: 0.50

焊盘长: 0.80

技术要求:

1, 塑封体尺寸: 2.70 X 1.60

2: 未注公差为: ±0.05

3, 所有单位: mm

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